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SYNTHETIC PAPER MADE

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OF STRETCHED

POLYPROPYLENE FILM

Assistant Commissioner for Patents Washington, D.C. 20231

LETTER

Responsive to the Notice of Non-Complaint Amendment mailed October 22, 2002 by the Patent and Trademark Office in the above-identified application, it is respectfully pointed out that a marked-up version of the amended claims was submitted with the amendment filed August 5, 2002.

In any event, a potentially clearer marked-up version of the amended claims is enclosed herewith.

Respectfully submitted, DILWORTH & BARRESE LLP.

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Date: November 22, 2002

George M. Kaplan

A synthetic paper which comprises a film obtained by

oxidizing the surface of a film obtained by stretching a resin film comprising as the base material a resin composition comprising

100 parts by weight of resin components <u>and from 10 to 250 parts by weight of component E:fine inorganic particles;</u>

said resin components comprising, based on the total weight of the resin components;

55-90 wt% of component A: a polypropylene resin. [55-90 wt%]

5-40 wt% of component B: a polyetheresteramide containing aromatic

rings which is derived from

component bl: a polyamide having a number-average molecular weight of from 200 to 5,000 and containing a carboxyl group at each end. and

component b2: an [alkaline] <u>alkylene</u> oxide adduct of bisphenol having a number-average molecular weight of from 300 to 5,000, [5-40 wt%]

3-20 wt% of component C: a polyamide resin, [3-20 wt%] and

1-20 wt% of component D: at least one modified low-molecular weight polypropylene selected from the group consisting of

[following components d1 to d3]

[1-20 wt %]

component dl: an acid-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and an acid value of from 5 to 150,

component d2: a hydroxy-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and a hydroxyl value of from 5 to 150, and

component d3: an ester-modified low-molecular weight polypropylene obtained by partly or wholly esterifying component d1 with a polyoxyalkylene compound and having a number-average molecular weight of from 1,000 to 28,000; [,]

[the total amount of all resin components being 100 wt%;

and

from 10 to 250 parts by weight of

component E: fine inorganic particles,]

said stretching being conducted at a temperature lower than the melting point of the polypropylene resin as component A, said stretching and oxidation of said stretched film generating ultrafine cracks on a surface of said stretched film through which component B as permanent antistatic agent appears and possessing gloss of 60% or below and opaqueness of 83% or above.

3. A synthetic paper which comprises a film obtained by oxidizing the surface of a film obtained by stretching a resin film comprising as the base material a resin composition comprising

100 parts by weight of resin components and from 10 to 250 parts by weight of component E:fine inorganic particles;

said resin components comprising, based on the total weight of the resin components,

55-90 wt% of component A: a polypropylene resin,

[55-90 wt%]

5-40 wt% of component B: a polyetheresteramide containing aromatic

rings which is derived from

component bl: a polyamide having a number-average molecular weight of from 200 to 5,000 and containing a carboxyl group at each end, and

component b2: an [alkaline] <u>alkylene</u> oxide adduct of bisphenol having a number-average molecular weight of from 300 to 5,000, [5-40 wt%]

3-20 wt% of component C: a polyamide resin, [3-20 wt%] and

1-20 wt% of component D: at least one modified low-molecular weight polypropylene selected from the group consisting of [following components d1 to d3 1-20 wt%]

component dl: an acid-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and an acid value of from 5 to 150,

component d2: a hydroxy-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and a hydroxyl value of from 5 to 150, and

component d3: an ester-modified low-molecular weight polypropylene obtained by partly or wholly esterifying component d1 with a polyoxyalkylene compound and having a number-average molecular weight of from 1,000 to 28,000; [,]

[The total amount of all resin components being 100 wt%, and from 10 to 250 parts by weight of component E: Fine inorganic particles,]

said stretching being conducted at a temperature lower than the melting point of the polypropylene resin as component A, wherein the stretched resin film has a void content of from 10 to 60% as calculated using the following equation (1): [of from 10 to 60%]

Void content (%) = $(\rho^{\circ}-\rho) \times 100/\rho^{\circ}$ (1) wherein ρ° [:] <u>is a density of the unstretched film, and</u> ρ [:] <u>is a density of the stretched film.</u>